THALES

3G
Cinterion® EHS5 Wireless Module
Highly Efficient 3G in a 2G Footprint

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EHS5

- **Dual Band HSPA**
- **Multi Design Capability (LGA)**
- **USB 2.0 High Speed compatible**
- **Embedded TCP/IP Stack**
- **FOTA** configurable & free of charge

- **Java embedded**
- **RLS Monitoring (Jamming Detection)**
- **Advanced Temperature Management**
- **eCall / ERA GLONASS Compliant**
- **Bearer Independent Protocol**

The Cinterion EHS5 module represents a milestone in embedded Java machine-to-machine (M2M) communication, offering smart connectivity for industrial applications.

EHS5 delivers highly efficient 3G communication in an ultra-compact footprint. EHS5 is an ideal solution for M2M applications moving to 3G technology with a focus on long-lasting, futureproof and cost efficient M2M applications. Offering a backward and forward compatible footprint, its multi design capability offers seamless migration and unmatched flexibility to choose frequency bands and global roaming whenever needed.
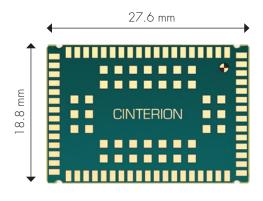
The platform incorporates an improved Java concept using Multi MIDlet Java execution to simultaneously host and run multiple applications and protocols. An extended security concept with the latest TLS/DTLS engine provides secure and reliable TCP/IP connectivity while an enriched internal flash file system enables free of charge firmware updates over-the-air (FOTA) when required. Sophisticated sandbox modeling and layered architectures simplify device management (DM) and separate

mobile network operator approvals from application code development, allowing simultaneous progress of both phases for a shorter time to market.

Powered by Intel's latest HSPA baseband, the next generation of the award-winning Industrial platform features high speed data communication with 7.2 Mbps (max) in the downlink and 5.76 Mbps (max) in the uplink.

The tiny EHS5 comes in Thales M2M's unique LGA (Land Grid Array) package perfectly suited to the manufacturing needs of small, high-volume M2M devices with a focus on reliable and efficient processes. EHS5 supports voice and data communication and best in class low power consumption incorporated with common industrial interfaces such as USB and serial interfaces.

EHS5 is available in two variants: EHS5-US (850/1900 MHz) for North America, and EHS5-E (900/2100 MHz) for the rest of the world.

Perfect M2M at Minimal Footprint

27.6 mm

18.8 mm

CINTERION

BIP (Bearer Independent Protocol)

BIP secures broadband speed to eUICC (MIM / classic) to enable On-Demand Provision Service (OPS) and Remote Application Management by direct communication between eUICC and network based on internal TCP/IP stack. As a result it enables instant data connectivity on 1st use of a device, as well as a flexible mobile subscription throughout the lifecycle and a reduced number of customer device variants.

eCall/ ERA glonass

Equipped with high performance e-call/GLONASS, the EHS5 platform is already prepared to meet the comprehensive requirements of the European eCall and ERA-GLONASS initiatives to bring rapid assistance to motorists involved in a collision.

Java™

Java offers easy and fast application development, a broad choice of tools, high code reusability, easy maintenance, a proven security concept, on-device debugging as well as multi-threading programming and program execution.

Thales M2M Support includes:

❚ Personal design-in consulting for hardware and software

❚ Extensive RF test capabilities

❚ GCF/PTCRB conform pretests to validate approval readiness

❚ Regular training workshops

Local engineers, a competent helpdesk, a dedicated team of R&D specialists and an advanced development center are the hallmarks of our leading support offer.

Cinterion® EHS5 Features

General Features

❚ 3GPP Rel.7 Compliant Protocol Stack

❚ Dual-Band UMTS (WCDMA/FDD)
EHS5-E: 900 and 2100 MHz
EHS5-US: 850 and 1900 MHz

❚ Dual-Band GSM
EHS5-E: 900 and 1800 MHz
EHS5-US: 850 and 1900 MHz

❚ SIM Application Toolkit, Class 3, with BIP and RunAT support

❚ 3GPP & Russian eCall support

❚ Embedded IP stack

❚ Control via standardized and extended AT commands (Hayes, TS 27.007 and 27.005)

❚ TCP/IP stack access via AT command and transparent TCP/UDP services

❚ Secure Connection with TLS/DTLS

❚ Internet Services TCP/UDP server/client, DNS, Ping, HTTP client

❚ Supply voltage range 3.1 - 4.5 V, highly optimized for minimal power consumption

❚ LGA66 soldering mount, MSL4

❚ Dimension: 27.6 x 18.8 x 2.2 mm

❚ Weight: 2.7 g

❚ Operating Temperature: -40 °C to +90 °C

Specifications

❚ HSDPA Cat.8 / HSUPA Cat.6 data rates
DL: max. 7.2 Mbps, UL: max. 5.76 Mbps

❚ EDGE Class 12 data rates
DL: max. 237 kbps, UL: max. 237 kbps

❚ GPRS Class 12 data rates
DL: max. 85.6 kbps, UL: max. 85.6 kbps

❚ CSD data transmission up to 9.6 kbps, V.110, non-transparent

❚ SMS text and PDU mode, cell broadcast

❚ High quality voice support for handset, headset and hands-free operation

❚ Integrated TTY modem

❚ Speech codec: FR, HR, EFR and AMR

Special Features

- USB interface supports multiple composite mode and a Linux-/Mac- compliant mode
- Firmware update via USB and serial interface
- Real time clock with alarm functionality
- Multiplexer according 3GPP TS 27.010
- RLS Monitoring (Jamming detection) in 2G and 3G
- Informal Network Scan
- Customer IMEI/SIM-Lock as variant
- Integrated FOTA, configurable and free of charge
- Cell ID based Location Support
- LwM2M support

Java Open Platform

- Java™ ME 3.2
- Secure data transmission with HTTPS/SSL
- Multi-Threading programming and Multi-Application execution
- 10 MB RAM and 13 MB Flash File System

Interfaces (LGA Pads)

- Pad for GSM/WCDMA Antenna
- USB 2.0 HS interface up to 480 Mbps
- High speed serial modem interface ASC0

- HSIC HS interface up to 480 Mbps
- 16 GPIO lines shared with DSR, DTR, DCD (all ASC0), ASC1 (RXD, TXD, RTS, CTS), SPI, Fast-Shutdown, Network-Status-Indication, PWM and Pulse-Counter lines
- ADC and I2C interface
- 4-wire high speed serial interface ASC1
- Digital audio interface
- UICC and U/SIM card interface 1.8 V / 3 V
- Lines for Module-On and Reset

Drivers

- USB, MUX driver for Microsoft® Windows XP™, Vista™ and 7™, 8™ and 10™
- RIL driver for Android, USB driver for Microsoft® Windows Embedded-Handheld™ >= 6.x
- USB, MUX driver for Microsoft® Windows Embedded-Compact™ >= 5.x

Approvals

- EHS5-E: CE, R&TTE
- EHS5-US: FCC, PTRCB, UL, IC
- GCF Listing
- AT&T and other local approvals and provider certifications
- EuP, RoHS and REACH compliant

Thales in IoT:
Driving digital transformation with the power of the IoT

Thales delivers innovative IoT technology that simplifies and speeds enterprise digital transformation. For more than 20 years, our customers – in a wide range of industries - trust our IoT solutions to seamlessly connect and secure their IoT devices, maximise field insights, and accelerate their global business success.

Thales solutions:

- **Connect** assets to wireless networks and cloud platforms
- **Manage** the long lifecycle of IoT solutions
- **Secure** devices and their data
- **Analyse** real-time data transforming it into business intelligence that improves decision making

Our 360° approach provides the essential building blocks needed to simplify design, streamline development and accelerate time-to-market.

For more information, please visit **www.thalesgroup.com/IoT** or follow **@ThalesIoT on Twitter**